# PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

| SUBMISSION TYPE:      | NEW ASSIGNMENT |
|-----------------------|----------------|
| NATURE OF CONVEYANCE: | ASSIGNMENT     |

### **CONVEYING PARTY DATA**

| Name            | Execution Date |
|-----------------|----------------|
| Richard Lindsay | 08/30/2006     |

### **RECEIVING PARTY DATA**

| Name:           | Infineon Technologies North America Corp. |  |
|-----------------|---|--|
| Street Address: | 1730 North First Street                   |  |
| City:           | San Jose                                  |  |
| State/Country:  | CALIFORNIA                                |  |
| Postal Code:    | 95112                                     |  |

### PROPERTY NUMBERS Total: 1

| Property Type       | Number   |
|---------------------|----------|
| Application Number: | 11521802 |

## **CORRESPONDENCE DATA**

Fax Number: (919)678-1899

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 919-677-3024

Email: ifna.ip@infineon.com

Correspondent Name: Heather Rowland

Address Line 1: 3000 CentreGreen Way

Address Line 4: Cary, NORTH CAROLINA 27513

ATTORNEY DOCKET NUMBER: 2006P50537US

NAME OF SUBMITTER: Heather Rowland

Total Attachments: 2

source=\_1016092725\_001#page1.tif source=\_1016092725\_001#page2.tif \$40.00

PATENT REEL: 018397 FRAME: 0001

#### ASSIGNMENT

For good and valuable consideration, I, **Richard Lindsay**, a citizen of the United Kingdom, residing at 524 Jefferson Blvd., Fishkill, NY, US 12524;

Hereby sell, assign and transfer to Infineon Technologies North America Corp., a corporation organized and existing under the state laws of Delaware, having its principal place of business at 1730 North First Street, San Jose, CA, 95112, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and filed herewith, entitled:

# Strained Semiconductor Device and Method of Making Same

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

PATENT REEL: 018397 FRAME: 0002 I hereby declare that all statements made herein on my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both under 18 USC §1001 and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

| Full Name of First Inventor: Richard Lindsay                   |                |
|--|----------------|
| Inventor's Signature:  | Date: 8 /30/06 |
| Residence: Fishkill, NY, US                                    | ,              |
| Citizenship: United Kingdom                                    |                |
| Post Office Address: 524 Jefferson Blvd., Fishkill, NY 12524 I | US             |